74HC4060; 74HCT4060 14-stage binary ripple counter with oscillator Rev. 4 – 10 February 2016

Product data sheet

General description 1.

The 74HC4060; 74HCT4060 is a 14-stage ripple-carry counter/divider and oscillator with three oscillator terminals (RS, RTC and CTC), ten buffered parallel outputs (Q3 to Q9 and Q11 to Q13) and an overriding asynchronous master reset (MR). The oscillator configuration allows design of either RC or crystal oscillator circuits. The oscillator may be replaced by an external clock signal at input RS. In this case, keep the oscillator pins (RTC and CTC) floating. The counter advances on the HIGH-to-LOW transition of RS. A HIGH level on MR clears all counter stages and forces all outputs LOW, independent of the other input conditions. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

Features and benefits 2.

- All active components on chip
- RC or crystal oscillator configuration
- Complies with JEDEC standard no. 7 A
- Input levels:
 - For 74HC4060: CMOS level
 - For 74HCT4060: TTL level
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C

Applications 3.

- Control counters
- Timers
- **Frequency dividers**
- Time-delay circuits

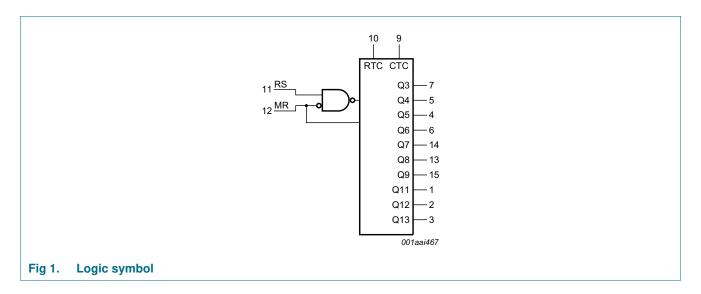


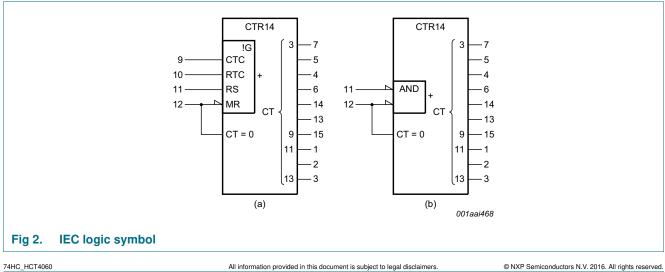
14-stage binary ripple counter with oscillator

Ordering information 4.

Type number	Package			
	Temperature range	Name	Description	Version
74HC4060D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1
74HCT4060D			body width 3.9 mm	
74HC4060DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads;	SOT338-1
74HCT4060DB			body width 5.3 mm	
74HC4060PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
74HC4060BQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal-enhanced	SOT763-1
74HCT4060BQ			very thin quad flat package; no leads; 16 terminals; body 2.5 \times 3.5 \times 0.85 mm	

5. **Functional diagram**





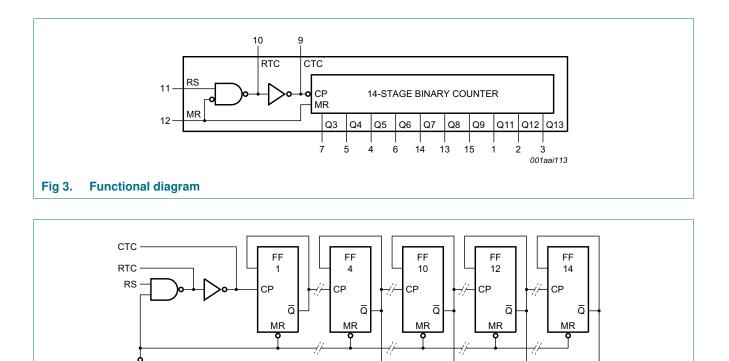
MR

Logic diagram

Fig 4.

74HC4060; 74HCT4060

14-stage binary ripple counter with oscillator



č Q3

Q9

Q11

74HC_HCT4060

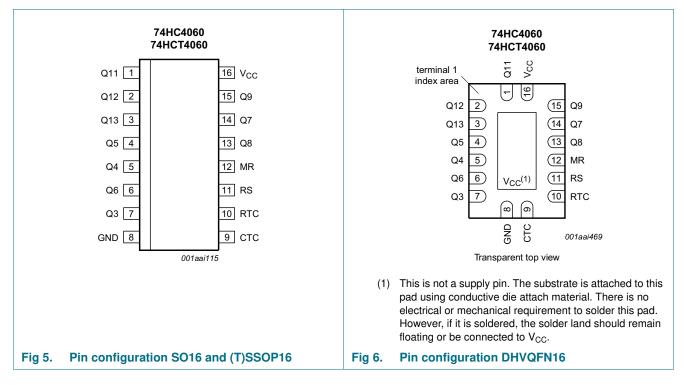
Q13

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14-stage binary ripple counter with oscillator

6. Pinning information

6.1 Pinning

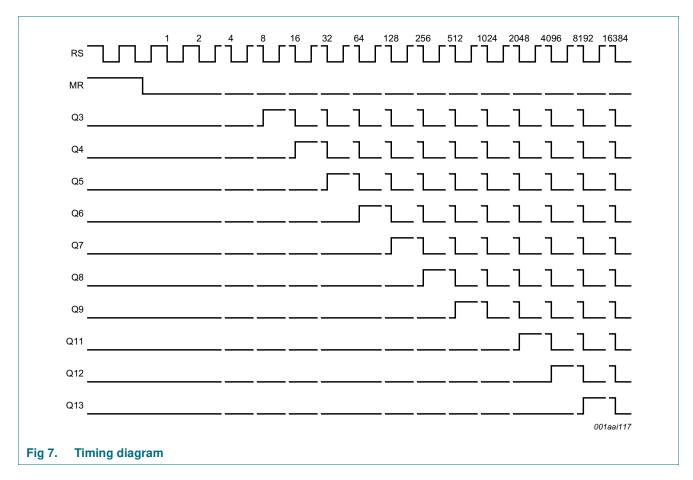


6.2 Pin description

Table 2. Pin description		
Symbol	Pin	Description
Q11 to Q13	1, 2, 3	counter output
Q3 to Q9	7, 5, 4, 6, 14, 13, 15	counter output
GND	8	ground (0 V)
CTC	9	external capacitor connection
RTC	10	external resistor connection
RS	11	clock input /oscillator pin
MR	12	master reset input (active HIGH)
V _{CC}	16	supply voltage

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7. Functional description



8. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{l} < -0.5 \text{ V or } V_{l} > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I _{OK}	output clamping current	$V_{\rm O} < -0.5 \text{ V or } V_{\rm O} > V_{\rm CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I _O	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C

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Table 3. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$			
		SO16 package [2]	-	500	mW
		(T)SSOP16 package [3]	-	500	mW
		DHVQFN16 package [4]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] P_{tot} derates linearly with 8 mW/K above 70 °C.

[3] P_{tot} derates linearly with 5.5 mW/K above 60 °C.

[4] P_{tot} derates linearly with 4.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 4. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Conditions 74HC4060				74HCT4060			
			Min	Тур	Max	Min	Тур	Max		
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V	
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V	
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V	
T _{amb}	ambient temperature		-40	-	+125	-40	-	+125	°C	
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V	
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V	
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V	

10. Static characteristics

Table 5. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 ℃	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC40	60									
V _{IH}	HIGH-level	MR input								
	input voltage	V _{CC} = 2.0 V	1.5	1.3	-	1.5	-	1.5	-	V
		$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.1	-	4.2	-	4.2	-	V
		RS input								
		V _{CC} = 2.0 V	1.7	-	-	1.7	-	1.7	-	V
		$V_{CC} = 4.5 V$	3.6	-	-	3.6	-	3.6	-	V
		V _{CC} = 6.0 V	4.8	-	-	4.8	-	4.8	-	V

14-stage binary ripple counter with oscillator

Table 5. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C te	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{IL}	LOW-level	MR input								
	input voltage	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
		RS input								-
		V _{CC} = 2.0 V	-	-	0.3	-	0.3	-	0.3	V
		V _{CC} = 4.5 V	-	-	0.9	-	0.9	-	0.9	V
		V _{CC} = 6.0 V	-	-	1.2	-	1.2	-	1.2	V
V _{OH}	HIGH-level	RTC output; RS = MR = GND								
	output	$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
	voltage	$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -2.6 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	-	-	3.84	-	3.7	-	V
		$I_{O} = -3.3 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	-	-	5.34	-	5.2	-	V
		RTC output; RS = MR = V_{CC}								
		$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -0.65 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	-	-	3.84	-	3.7	-	V
		$I_{O} = -0.85 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	-	-	5.34	-	5.2	-	V
		CTC output; RS = V_{IH} ; MR = V_{IL}								
		$I_{O} = -3.2 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	-	-	3.84	-	3.7	-	V
		$I_{O} = -4.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	-	-	5.34	-	5.2	-	V
		V _I = V _{IH} or V _{IL} ; except RTC output								
		$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$V_I = V_{IH}$ or V_{IL} ; except RTC and CTC outputs								
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	-	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	-	-	5.34	-	5.2	-	V

14-stage binary ripple counter with oscillator

Table 5. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{OL}	LOW-level output	RTC output; RS = V _{CC} ; MR = GND								
	voltage	$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 2.6 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.26	-	0.33	-	0.4	V
		$I_{O} = 3.3 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.26	-	0.33	-	0.4	V
		CTC output; RS = V_{IL} ; MR = V_{IH}								
		$I_{O} = 3.2 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.26	-	0.33	-	0.4	V
		$I_{O} = 4.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.26	-	0.33	-	0.4	V
		$V_I = V_{IH}$ or V_{IL} ; except RTC output								
		$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$V_I = V_{IH}$ or V_{IL} ; except RTC and CTC outputs								
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current		-	-	8.0	-	80	-	160	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT4	060	1				1				
V _{IH}	HIGH-level input voltage	MR input; [1] V _{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
		RS input; V _{CC} = 4.5 V	3.6	-	-	3.6	-	3.6	-	V
V _{IL}	LOW-level input voltage	MR input; [1] V _{CC} = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
	1	RS input; V _{CC} = 4.5 V			0.9		0.9		0.9	V

14-stage binary ripple counter with oscillator

Table 5. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C te	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{ОН}	HIGH-level	RTC output; RS = MR = V _{CC}								
	output	$I_{O} = -20 \ \mu A; V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
	voltage	$I_{O} = -0.65 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	-	-	3.84	-	3.7	-	V
		RTC output; RS = MR = GND								
		$I_{O} = -20 \ \mu A; V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -2.6 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	-	-	3.84	-	3.7	-	V
		CTC output; RS = V_{IH} ; MR = V_{IL}								
		$I_{O} = -3.2 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	-	-	3.84	-	3.7	-	V
		$V_I = V_{IH}$ or V_{IL} ; except RTC output								
		$I_{O} = -20 \ \mu A; V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$V_I = V_{IH}$ or V_{IL} ; except RTC and CTC outputs								
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	-	-	3.84	-	3.7	-	V
V _{OL}	LOW-level output	RTC output; RS = V_{CC} ; MR = GND								
	voltage	$I_{O} = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 2.6 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.26	-	0.33	-	0.4	V
		CTC output; RS = V_{IL} ; MR = V_{IH}								
		$I_{O} = 3.2 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.26	-	0.33	-	0.4	V
		V _I = V _{IH} or V _{IL} ; except RTC output								
		$I_{O} = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	-	0	0.1	-	0.1	-	0.1	V
		$V_I = V_{IH}$ or V_{IL} ; except RTC and CTC outputs								
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}; I_O = 0 \text{ A}$	-	-	8.0	-	80	-	160	μA
Δl _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$	-	40	144	-	180	-	196	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

[1] For HCT4060, only input MR (pin 12) has TTL input switching levels.

14-stage binary ripple counter with oscillator

11. Dynamic characteristics

Table 6. Dynamic characteristics

 $GND = 0 V; C_L = 50 pF$ unless otherwise specified; for test circuit see Figure 11.

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC406	60									
t _{pd}	propagation	RS to Q3; see Figure 8	1							
	delay	V _{CC} = 2.0 V	-	99	300	-	375	-	450	ns
		V _{CC} = 4.5 V	-	36	60	-	75	-	90	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	31	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	29	51	-	64	-	77	ns
		Qn to Qn+1; see Figure 9	1							
		V _{CC} = 2.0 V	-	22	80	-	100	-	120	ns
		V _{CC} = 4.5 V	-	8	16	-	20	-	24	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	6	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	6	14	-	17	-	20	ns
t _{PHL}	HIGH to LOW	MR to Qn; see Figure 10								
	propagation	V _{CC} = 2.0 V	-	55	175	-	220	-	265	ns
	delay	V _{CC} = 4.5 V	-	20	35	-	44	-	53	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	17	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	16	30	-	37	-	45	ns
t _t	transition time	Qn; see Figure 8	1							
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
tw	pulse width	RS (HIGH or LOW); see <u>Figure 8</u>								
		V _{CC} = 2.0 V	80	17	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	5	-	17	-	20	-	ns
		MR (HIGH); see Figure 10								
		V _{CC} = 2.0 V	80	25	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	9	-	20	-	24	-	ns
		$V_{\rm CC} = 6.0 \ {\rm V}$	14	7	-	17	-	20	-	ns
t _{rec}	recovery time	MR to RS; see Figure 10								
		V _{CC} = 2.0 V	100	28	-	125	-	150	-	ns
		$V_{\rm CC} = 4.5 \text{ V}$	20	10	-	25	-	30	-	ns
		$V_{\rm CC} = 6.0 \text{ V}$	17	8	-	21	-	26	_	ns

14-stage binary ripple counter with oscillator

Table 6. Dynamic characteristics ... continued

 $GND = 0 V; C_L = 50 pF$ unless otherwise specified; for test circuit see Figure 11.

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	-40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	-
f _{max}	maximum	RS; see Figure 8								
	frequency	V _{CC} = 2.0 V	6	26	-	4.8	-	4	-	MHz
		V _{CC} = 4.5 V	30	80	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	87	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	35	95	-	28	-	24	-	MHz
C _{PD}	power dissipation capacitance	$V_{I} = GND \text{ to } V_{CC}; \qquad \underline{f}$ $V_{CC} = 5 \text{ V}; f_{i} = 1 \text{ MHz}$	<u>H</u> -	40	-	-	-	-	-	pF
74HCT40	060					1		1		1
t _{pd}	propagation	RS to Q3; see Figure 8	1							
	delay	V _{CC} = 4.5 V	-	33	66	-	83	-	99	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	31	-	-	-	-	-	ns
		Qn to Qn+1; see Figure 9	2]							
		$V_{CC} = 4.5 V$	-	8	16	-	20	-	24	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	6	-	-	-	-	-	ns
t _{PHL}	HIGH to LOW	MR to Qn; see Figure 10								
	propagation delay	V _{CC} = 4.5 V	-	21	44	-	55	-	66	ns
	uelay	$V_{CC} = 5.0 \text{ V}; C_{L} = 15 \text{ pF}$	-	18	-	-	-	-	-	ns
t _t	transition time	Qn; see Figure 8	<u>81</u>							
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
tw	pulse width	RS (HIGH or LOW); see <u>Figure 8</u>								
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		MR (HIGH); see Figure 10								
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
t _{rec}	recovery time	MR to RS; see Figure 10								
		V _{CC} = 4.5 V	26	13	-	33	-	39	-	ns
f _{max}	maximum	RS; see Figure 8								
	frequency	V _{CC} = 4.5 V	30	80	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	88	-	-	-	-	-	MHz

14-stage binary ripple counter with oscillator

Table 6. Dynamic characteristics ... continued

 $GND = 0 V; C_L = 50 pF$ unless otherwise specified; for test circuit see Figure 11.

Symbol	Parameter	Conditions	25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
C _{PD}	power dissipation capacitance	$V_{I} = GND \text{ to } V_{CC} - 1.5 \text{ V};$ [4] $V_{CC} = 5 \text{ V}; f_{i} = 1 \text{ MHz}$	-	40	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

[2] Qn+1 is the next Qn output.

[3] t_t is the same as t_{THL} and t_{TLH} .

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W):

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = input frequency in MHz;$

 $f_o = output$ frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

12. Waveforms

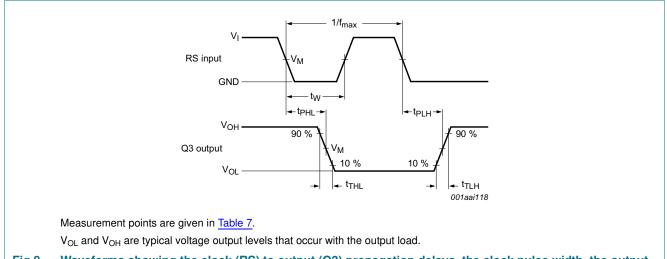
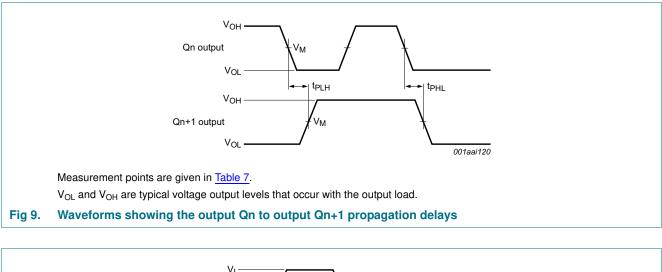


Fig 8. Waveforms showing the clock (RS) to output (Q3) propagation delays, the clock pulse width, the output transition times and the maximum clock frequency

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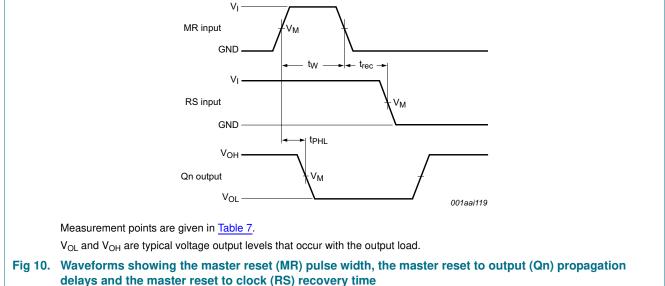


Table 7.Measurement points

Туре	Input	Output
	V _M	V _M
74HC4060	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
74HCT4060	1.3 V	1.3 V

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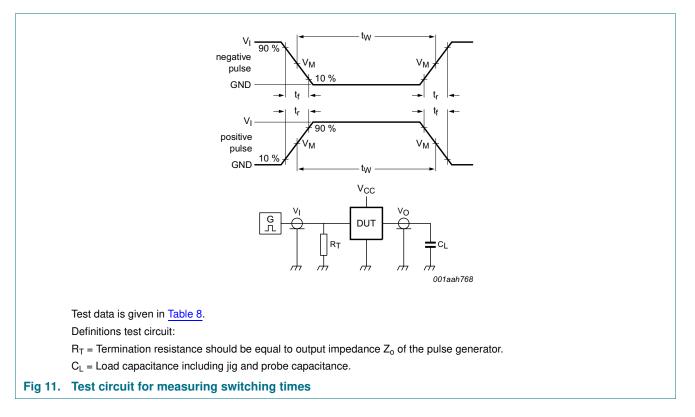


Table 8. Test data

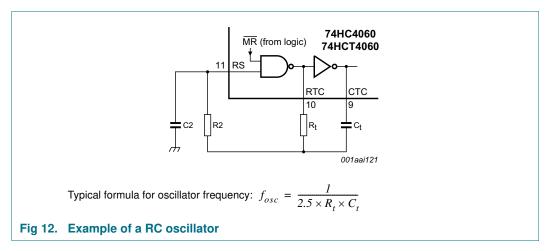
Туре	Input		Load
	VI	t _r , t _f	CL
74HC4060	V _{CC}	6 ns	15 pF, 50 pF
74HCT4060	3 V	6 ns	15 pF, 50 pF

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13. RC oscillator

13.1 Timing component limitations

The oscillator frequency is mainly determined by R_tC_t , provided $R2 \approx 2R_t$ and $R2C2 << R_tC_t$. The function of R2 is to minimize the influence of the forward voltage across the input protection diodes on the frequency. The stray capacitance C2 should be kept as small as possible. In consideration of accuracy, C_t must be larger than the inherent stray capacitance. R_t must be larger than the ON resistance in series with it, which typically is 280 Ω at $V_{CC} = 2.0$ V, 130 Ω at $V_{CC} = 4.5$ V and 100 Ω at $V_{CC} = 6.0$ V.



The recommended values for these components to maintain agreement with the typical oscillation formula are:

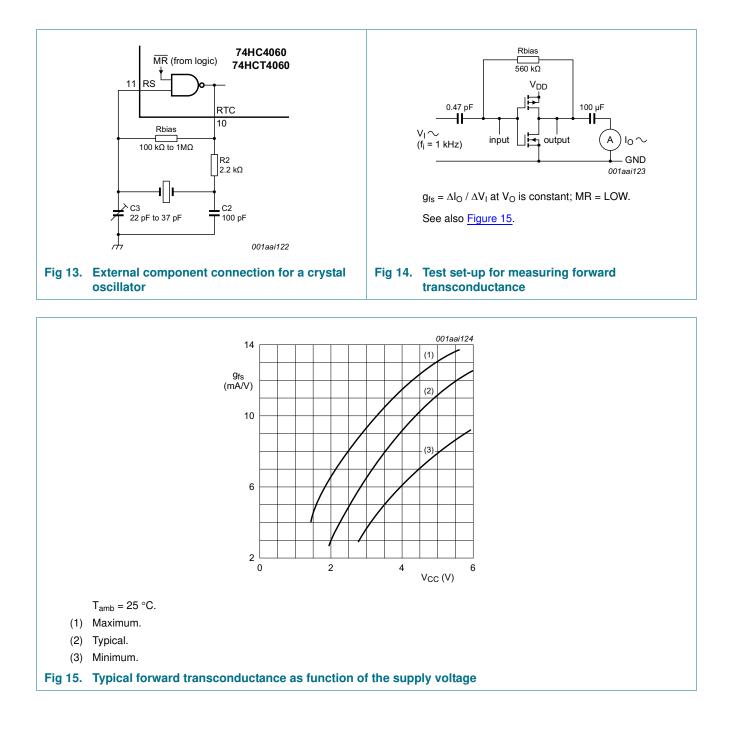
 C_t > 50 pF, up to any practical value and 10 k Ω < R_t < 1 M $\Omega.$

In order to avoid start-up problems, $R_t \ge 1 \ k\Omega$.

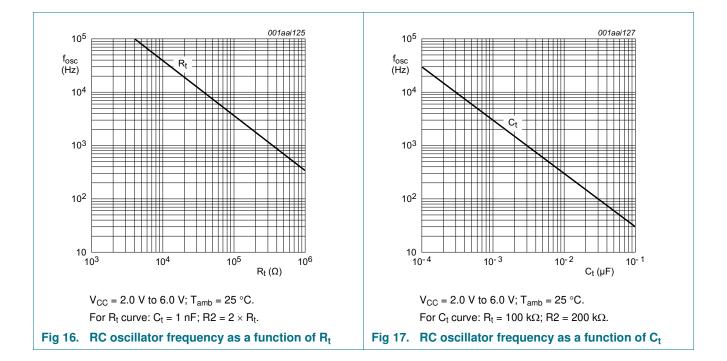
13.2 Typical crystal oscillator circuit

In <u>Figure 13</u>, R2 is the power limiting resistor. For starting and maintaining oscillation a minimum transconductance is necessary, so R2 should not be too large. A practical value for R2 is 2.2 k Ω .

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14. Package outline

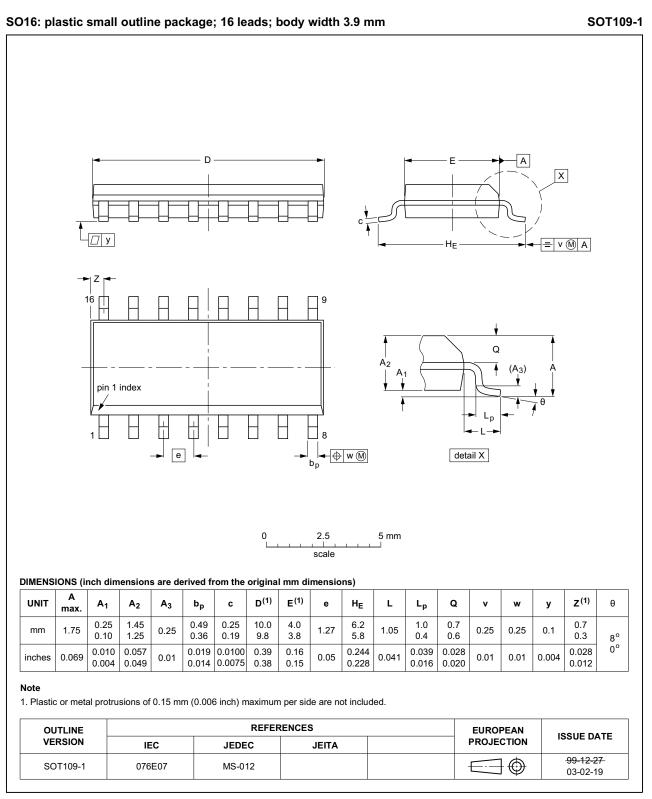


Fig 18. Package outline SOT109-1 (SO16)

14-stage binary ripple counter with oscillator

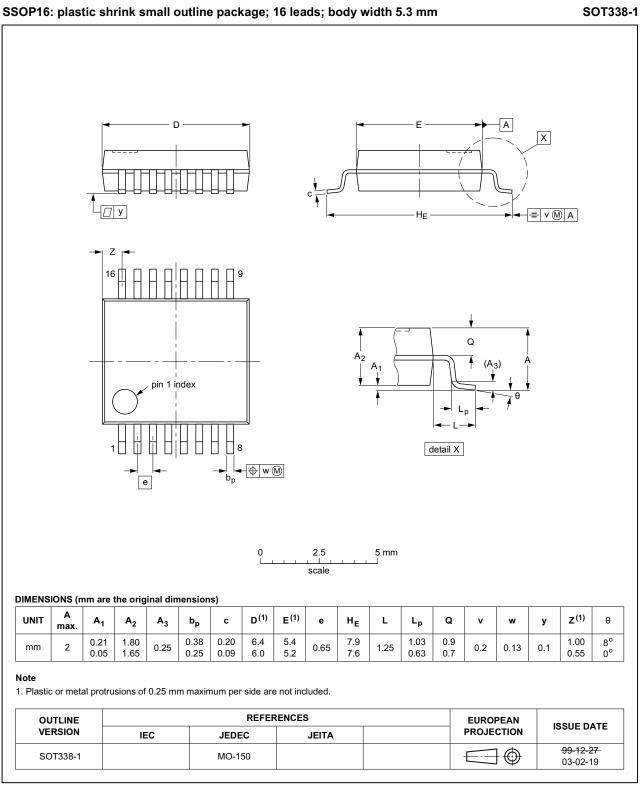


Fig 19. Package outline SOT338-1 (SSOP16)

74HC_HCT4060

Product data sheet

14-stage binary ripple counter with oscillator

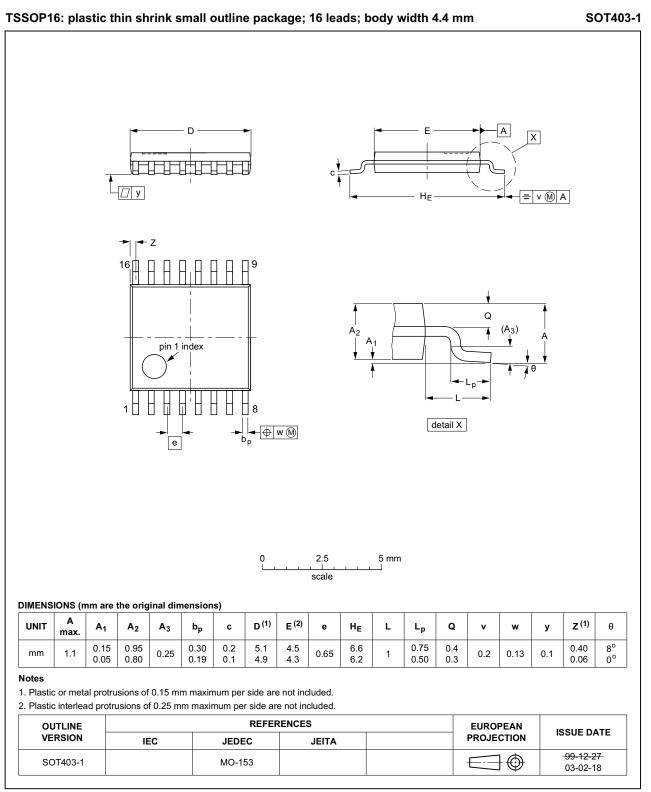
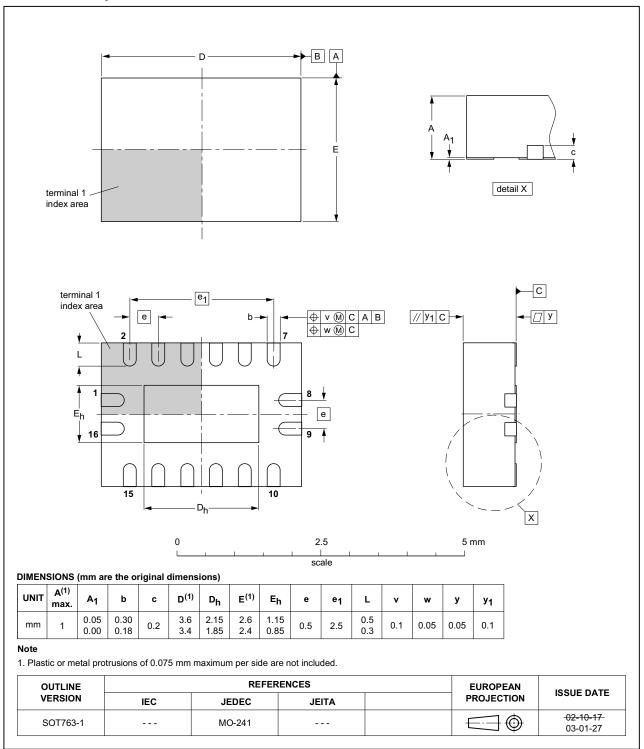


Fig 20. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

Fig 21. Package outline SOT763-1 (DHVQFN16)

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15. Abbreviations

Table 9. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

16. Revision history

Table 10.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74HC_HCT4060 v.4	20160210	Product data sheet	-	74HC_HCT4060 v.3		
Modifications:	Type numbers 74HC4060N and 74HCT4060N (SOT38-4) removed.					
	• <u>Table 5</u> : HIG	<u>Table 5</u> : HIGH and LOW input levels added for 74HCT4060. (errata)				
74HC_HCT4060 v.3	20080714	Product data sheet	-	74HC_HCT4060_CNV v.2		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts have been adapted to the new company name where appropriate. 					
 <u>Section 4</u>: DHVQFN16 package added. 						
	 <u>Section 8</u>: derating values added for DHVQFN16 package. 					
	 <u>Section 14</u>: outline drawing added for DHVQFN16 package. 					
74HC_HCT4060_CNV v.2	19970901	Product specification	-	-		

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17. Legal information

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Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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